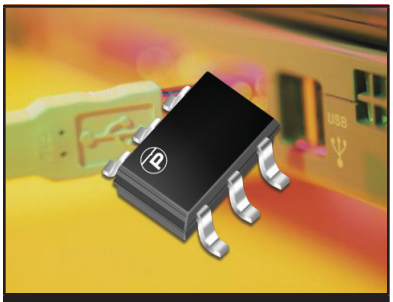
LOW CAPACITANCE TVS ARRAY



SOT-23-6 PACKAGE

DESCRIPTION

The ESDA05C-5, is a high frequency, transient suppression protector of computer and telecommuniction systems. This device is packaged in a SOT-23-6 plastic case and is available in a 5 volt, bidirectional configuration.

Due to its low capacitance, the ESDA05C-5 is ideal protection of computer port interfaces against the effects of electrostatic discharge (ESD) and electrical fast transients (EFT). This device meets the requirements of IEC 61000-4-2 and IEC 61000-4-4.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A, 5/50ns
- 80 Watts Peak Pulse Power per Line(tp = 8/20µs)
- Protection for 5 Lines
- Bidirectional Configuration
- Low Clamping Voltage
- Low Leakage Current < 1µA
- Low Capacitance < 15pF per Diode
- RoHS Compliant
- REACH Compliant

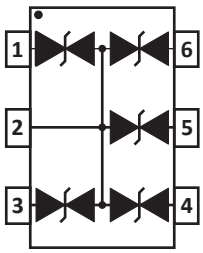
APPLICATIONS

- Set-Top Box Interfaces
- Computer Interfaces
- Communications Equipment

MECHANICAL CHARACTERISTICS

- Molded JEDEC SOT-23-6 Package
- Approximate Weight: 16 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
  Pure-Tin - Sn, 100: 260-270°C
- Flammability Rating UL 94V-0
- 8mm Tape and Reel per EIA Standard 481

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified			
PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power (tp = 8/20µs) - See Figure 1	P_{PP}	80	Watts
Operating Temperature	T_L	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified					
PART NUMBER (Note 1)	DEVICE MARKING	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM LEAKAGE CURRENT @V_{WM} I_D µA	TYPICAL CAPACITANCE (Note 2) @0V, 1MHz C pF
ESDA05C-5	ED5	5.0	6.1	1	15

NOTES
1. Bidirectional Only: Test between pins 2 to 1, 2 to 6, 2 to 5, 2 to 4 and 2 to 3. Electrical characteristics apply in both directions.
2. Bidirectional Only: Capacitance measured between pins 1, 3, 4, 5 and 6 to 2.

TYPICAL DEVICE CHARACTERISTICS

FIGURE 1
PEAK PULSE POWER VS PULSE TIME

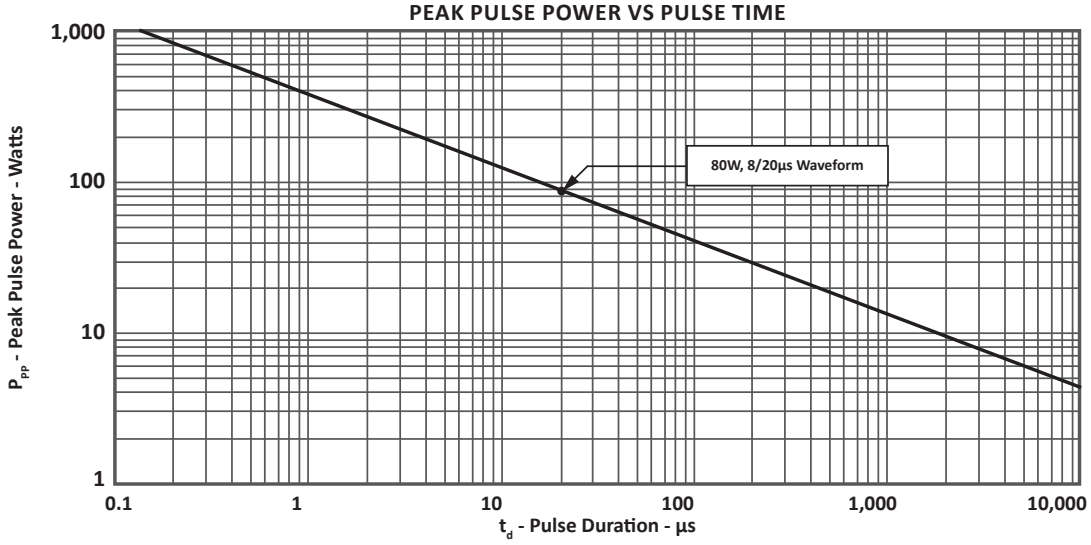
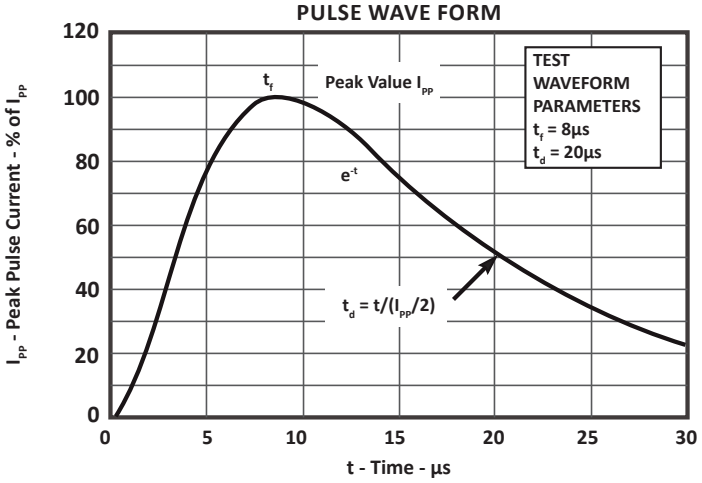


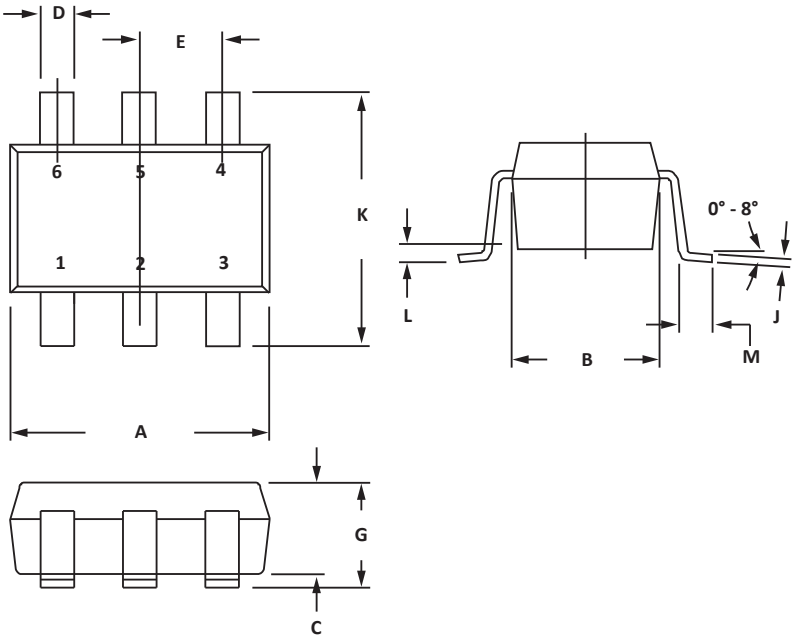
FIGURE 2
PULSE WAVE FORM



SOT-23-6 PACKAGE INFORMATION

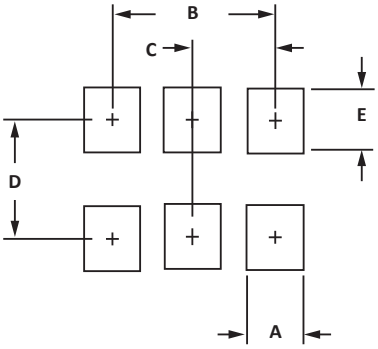
OUTLINE DIMENSIONS				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.80	3.05	0.110	0.120
B	1.50	1.75	0.059	0.070
C	0.90	1.30	0.036	0.051
D	0.30	0.40	0.012	0.016
E	0.85	1.05	0.033	0.040
G	0.90	1.45	0.036	0.057
J	0.09	0.20	0.003	0.008
K	2.60	3.00	0.102	0.118
L	0.0	0.15	0.0	0.006
M	0.30	0.60	0.012	0.024

NOTES
1. Controlling dimension: inches.
2. Dimensioning and tolerances per ANSI Y14.5M, 1985.
3. Dimensions are exclusive of mold flash and metal burrs.

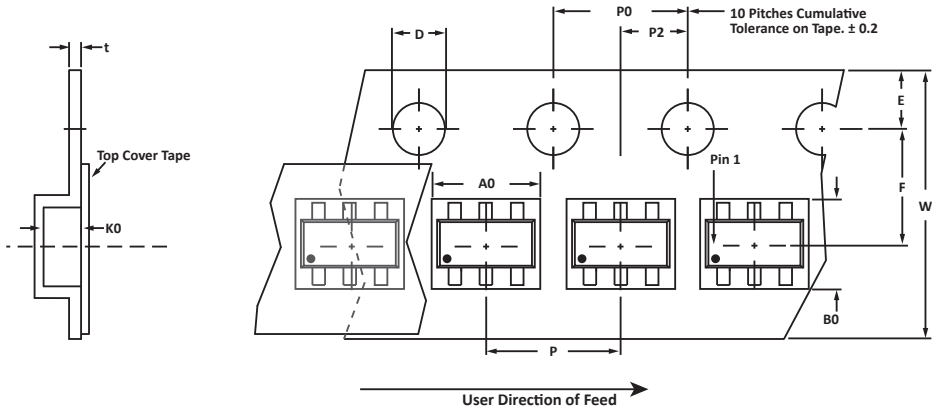


PAD LAYOUT DIMENSIONS		
DIM	MILLIMETERS	INCHES
	NOMINAL	NOMINAL
A	0.70	0.028
B	1.90	0.074
C	0.95	0.037
D	2.40	0.094
E	1.00	0.039

NOTES
1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	8mm	3.20 ± 0.10	3.20 ± 0.10	1.65 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.25

NOTES
1. Dimensions are in millimeters.
2. Surface mount product is taped and reeled in accordance with EIA-481.
3. Suffix - T7 = 7" Reel - 3,000 pieces per 8mm tape.
4. Marking on Part - marking code (see page 2) and pin one defined by dot on package.

Package outline, pad layout and tape specifications per document number 06013.R5 2/11

ORDERING INFORMATION					
BASE PART NUMBER	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
ESDA05C-5	-LF	-T7	3,000	7"	n/a

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

CONTACT US

Corporate Headquarters
2929 South Fair Lane
Tempe, Arizona 85282
USA

By Telephone
General: 602-431-8101
Sales: & Marketing: 602-414-5109
Customer Service: 602-414-5114
Product Technical Support: 602-414-5107

By Fax
General: 602-431-2288

By E-mail:
Asia Sales: asiasales@protekdevices.com
Europe Sales: europesales@protekdevices.com
U.S. Sales: ussales@protekdevices.com
Distributor Sales: distysales@protekdevices.com
Customer Service: service@protekdevices.com
Technical Support: support@protekdevices.com

ProTek Devices (Asia Pacific) Pte. Ltd.
8 Ubi Road 2, #06-19
Zervex
Singapore - 408538
Tel: +65-67488312
Fax: +65-67488313

Web
www.protekdevices.com